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Renesas Electronics Corporation

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## H8/300H Tiny Series

### Signed 32-Bit Binary Division with a 32-Bit Divisor (DIVS)

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#### Introduction

Performs division in this format:

dividend (signed, 32 bits) / divisor (signed, 32 bits) = quotient (signed, 32 bits) ... remainder (signed, 32 bits).

#### Target Device

H8/300H Tiny Series

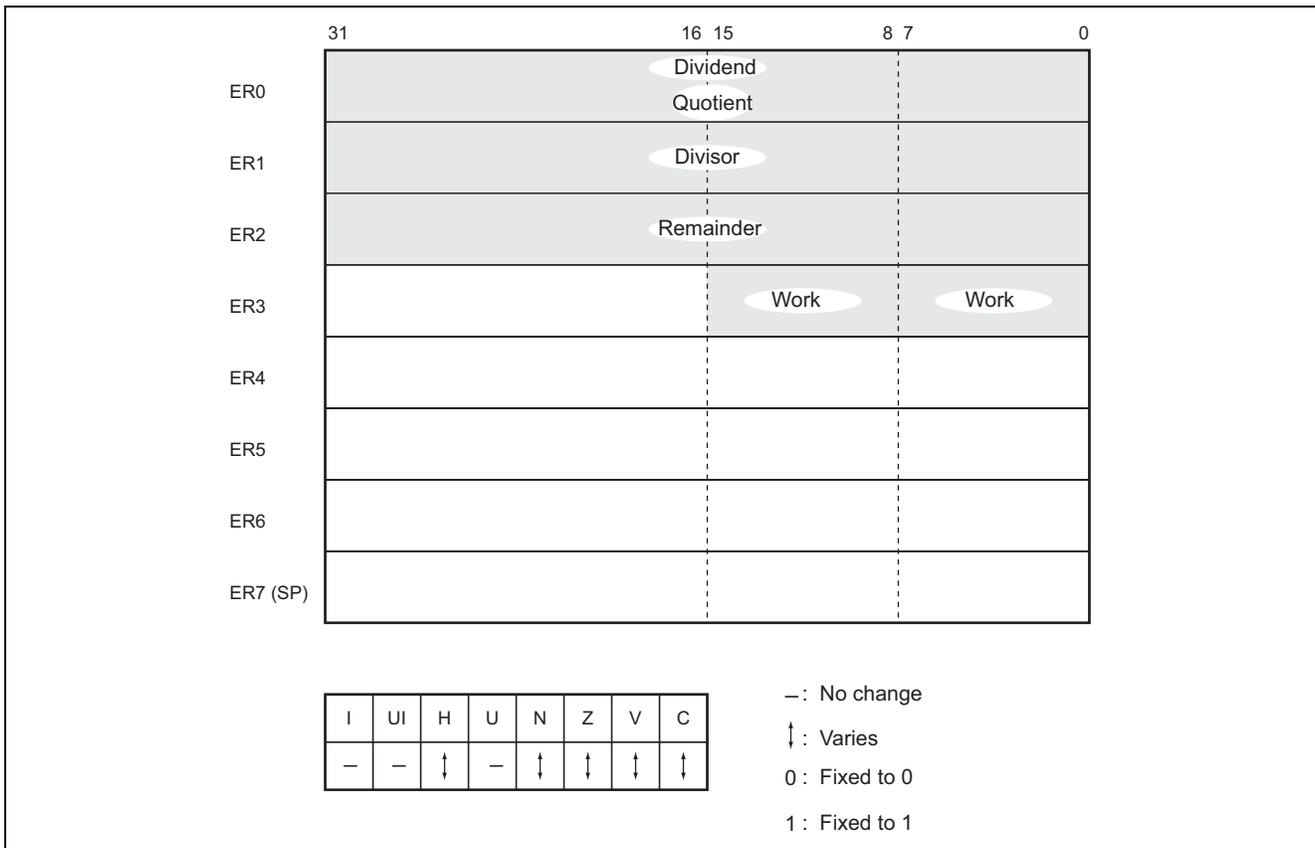
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### 1. Arguments

Description		Storage Location	Data Length (Bytes)
Input	Dividend (signed, 32 bits)	ER0	4
	Divisor (signed, 32 bits)	ER1	4
Output	Quotient (signed, 32 bits)	ER0	4
	Remainder (signed, 32 bits)	ER2	4
	Occurrence of error	Z flag (CCR)	—

### 2. Changes to Internal Registers and Flags



### 3. Programming Specifications

	Program memory (bytes)	
	66	
	Data memory (bytes)	
	0	
	Stack (bytes)	
	0	
	Number of cycles	
	770	
	Re-entrant	
	Yes	
	Relocatable	
	Yes	
	Interrupts during execution	
	Yes	

### 4. Note

The number of cycles in the programming specifications is the value for calculation of  $H'80000000 / H'7FFFFFFF$ .

## 5. Description

### 5.1 Description of Functions

1. The arguments are as follows.

ER0: Set the divisor (signed, 32 bits) as an input argument. The quotient (signed, 32 bits) is also set here as an output argument.

ER1: Set the divisor (signed, 32 bits) as an input argument.

ER2: The remainder (signed, 32 bits) is set here as an output argument.

Z flag (CCR): Indicates whether there are any errors (division by 0) after execution of DIVS.

Z flag = 1: The division was in error.

Z flag = 0: The division was processed without error.

2. The following figure illustrates the execution of the DIVS subroutine. When the input arguments are set as shown below, DIVS places the quotient in ER0 and the remainder in ER1.

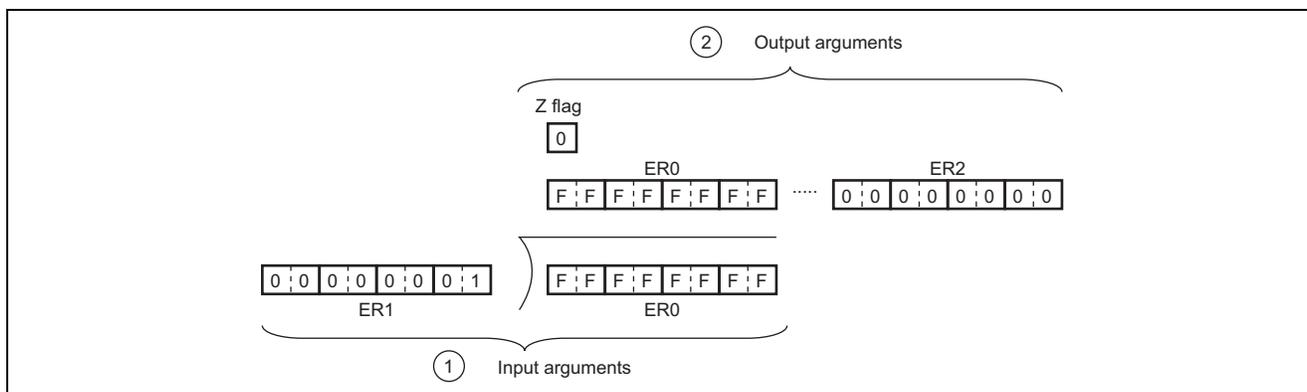


Figure 1 Example of DIVS Execution

3. When the divisor is 0, DIVS ends immediately.

### 5.2 Usage Notes

Since the quotient is set in ER0, the dividend is lost after DIVS is executed. When you will still require the dividend, save it elsewhere in memory beforehand.

### 5.3 Description of Data Memory

No data memory is used by DIVS.

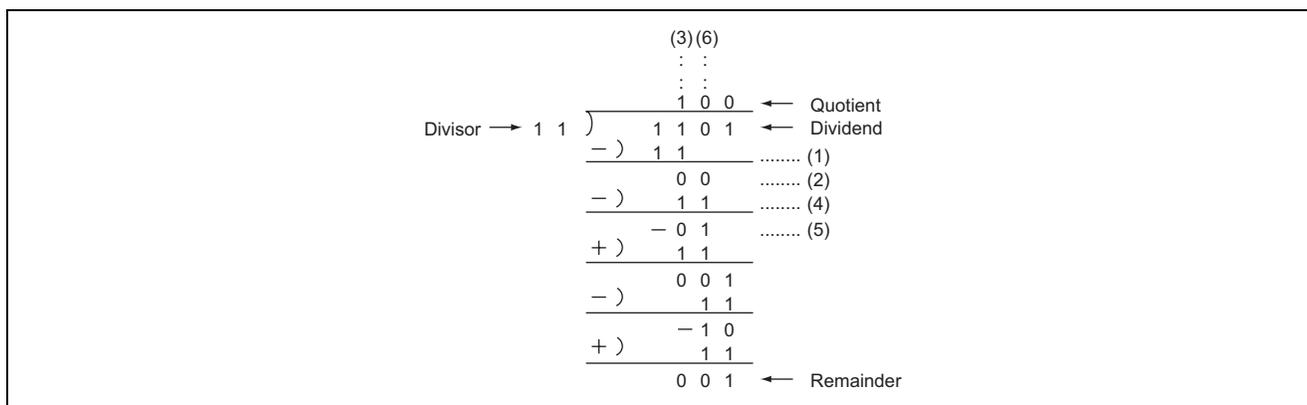
## 5.4 Examples of Usage

After setting the dividend and divisor, call the DIVS subroutine.

WORK1	. RES. L 1	.....	Reservation of the data memory area for setting of the dividend (signed, 32 bits) by the user program.
WORK2	. RES. L 1	.....	Reservation of the data memory area for setting of the divisor (signed, 32 bits) by the user program.
	.		
	.		
	MOV. L @WORK1, ER0	.....	Sets, as an input argument, the dividend (signed, 32 bits) specified by the user program.
	MOV. L @WORK2, ER1	.....	Sets, as an input argument, the divisor (signed, 32 bits) specified by the user program.
	<span style="border: 1px solid black; padding: 2px;">JSR @DIVS</span>	.....	Subroutine call of DIVS.

### 5.5 Principles of Operation

1. Negative dividends and divisors are converted to positive numbers.
2. The quotient and remainder are found through repeated subtraction. In the figure below, the division of H'0D by H'03 is given as an example of this division operation.
  - 1) The initial number of shifts is set in the counter R3L, which indicates the number of shifts.
  - 2) The dividend is shifted 1 bit to the left and the MSB thus loaded to the C bit is set as the LSB of ER2 (which will hold the remainder).
  - 3) The divisor is subtracted from ER2. When the result of subtraction is positive, the LSB of ER0 is set ((1) → (2) → (3) in the figure). When the result of subtraction is negative, the LSB of ER0 is cleared and the divisor is added to the result of subtraction, returning it to the state prior to subtraction ((4) → (5) → (6) in the figure).
  - 4) The shift counter set in step 1) above is decremented.
  - 5) Steps 2) through 4) are repeated until the shift counter reaches -1.



**Figure 2 Division Example**

3. The quotient and/or remainder is then converted to negative if the sign flag is 1, as shown in table 1.

**Table 1 Sign of Division Results and the Sign Flag**

Dividend	Divisor	Quotient	Remainder	Quotient Sign Flag	Remainder Sign Flag
Positive	Positive	Positive	Positive	0	0
	Negative	Negative	Positive	1	0
Negative	Positive	Negative	Negative	1	1
	Negative	Positive	Positive	0	0

### 6. Program Listing

```

1          1          ;*****
2          2          ;*
3          3          ;*      NAME      : 32 BIT SIGNED DIVISION (DIVS)      *
4          4          ;*
5          5          ;*****
6          6          ;*
7          7          ;*      ENTRY      : ER0              (DIVIDEND)      *
8          8          ;*              ER1              (DIVISOR)        *
9          9          ;*      RETURNS   : ER0              (QUOTIENT)      *
10         10         ;*              ER2              (REMAINDER)     *
11         11         ;*
12         12         ;*****
13         13         ;
14         14         .CPU      300HA
15         15         .SECTION A, CODE, LOCATE=H'001000
16         16         DIVS    .EQU      $              ;Entry point
17         17         00001000  MOV.L    ER1, ER1              ;
18         18         001000  0F91    BEQ      DIVS7              ;
19         19         001002  5870004E  SUB.B    R3H, R3H              ;Clear FLAG
20         20         001006  1833    MOV.L    ER0, ER0              ;
21         21         001008  0F80    BPL     DIVS1              ;
22         22         00100A  58A00004  NIG.L    ER0              ;If minus then change to plus
23         23         001010  17B0    BNOT    #7, R3H              ;Clear FLAG
24         24         001012  0F91    DIVS1   MOV.L    ER1, ER1              ;
25         25         001014  58A00008  BPL     DIVS2              ;
26         26         001018  17B1    NEG.L    ER1              ;If minus then change to plus
27         27         00101A  7173    BNOT    #7, R3H              ;Clear FLAG
28         28         00101C  58000008  BRA     DIVS22             ;
29         29         001020  7373    DIVS2   BTST    #7, R3H              ;
30         30         001022  58700002  BEQ     DIVS22             ;
31         31         001026  7003    BSET    #0, R3H              ;
32         32         001028  FB20    DIVS22  MOV.B    #32, R3L             ;Set shift counter
33         33         00102A  1AA2    SUB.L    ER2, ER2             ;Clear remainder
34         34         00102C  1030    DIVS3   SHLL.L   ER0              ;Shift dividend 1 bit left
35         35         00102E  1232    ROTXL.L ER2              ;Set MSB of dividend to LSB of remainder
36         36         001030  1A92    SUB.L    ER1, ER2             ;Sub divisor from residual
37         37         001032  58400006  BCC     DIVS4              ;Branch if residual >= divisor
38         38         001036  0A92    ADD.L    ER1, ER2             ;Add divisor to residual
39         39         001038  58000002  BRA     DIVS5              ;Branch always
40         40         00103C  7008    DIVS4   BSET    #0, R0L             ;Set 1 to dividend LSB
41         41         00103E  1A0B    DIVS5   DEC.B    R3L              ;Decrement shift counter
42         42         001040  46EA    BNE     DIVS3              ;Branch until shift counter = 0
43         43         001042  7373    BTST    #7, R3H              ;
44         44         001044  58700002  BEQ     DIVS55             ;
45         45         001048  17B0    NEG.L    ER0              ;If FLAG = 1 then change to minus
46         46         00104A  7303    DIVS55  BTST    #0, R3H              ;
47         47         00104C  58700002  BEQ     DIVS6              ;
48         48         001050  17B2    NEG.L    ER2              ;quotient and residual
49         49         001052  06B2    DIVS6   ANDC    #B'11111011, CCR ;
50         50         001054  5470    RTS
51         51         .END
***** TOTAL      ERRORS      0
***** TOTAL      WARNINGS    0

```

Note: The program listing included in this application note assumes compilation under the option for the advanced mode of H8/300H CPU. If you use this sample program with an H8/300H Tiny Series product, make the following change to the program code:  
 .CPU 300HA → .CPU 300HN

### Revision Record

Rev.	Date	Description	
		Page	Summary
2.00	Feb.28.06	—	Format has been changed from Hitachi version to Renesas version.

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